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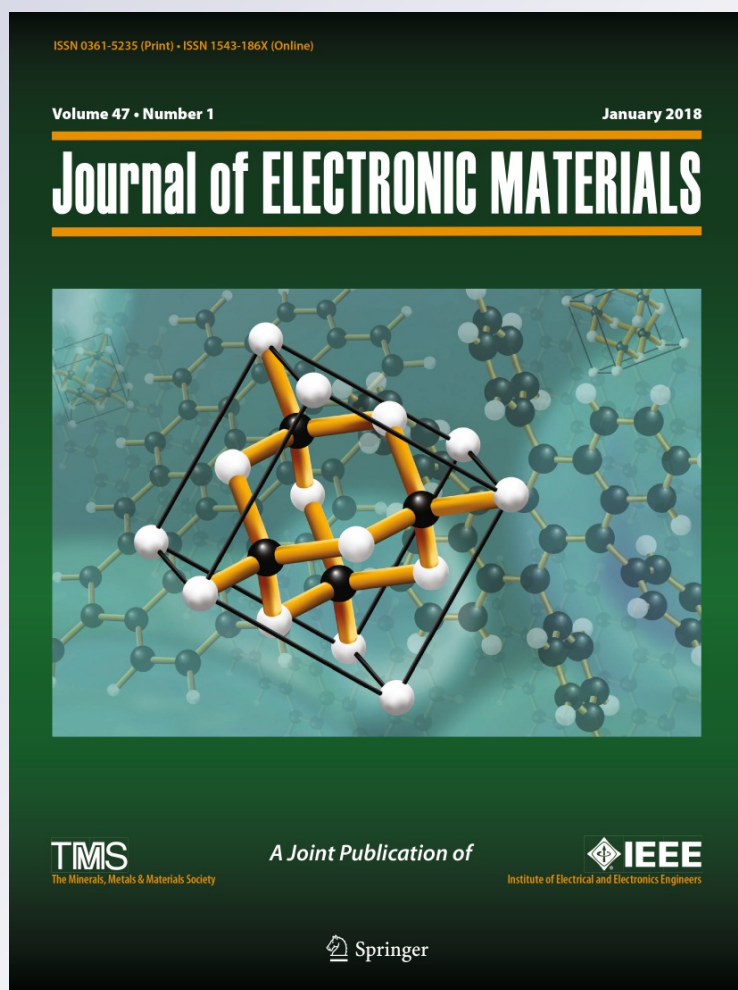
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# Tuning the Electronic Properties, Effective Mass and Carrier Mobility of MoS<sub>2</sub> Monolayer by Strain Engineering: First-Principle Calculations

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In this paper, we studied the electronic properties, effective masses, and carrier mobility of monolayer MoS<sub>2</sub> using density functional theory calculations. The carrier mobility was considered by means of *ab initio* calculations using the Boltzmann transport equation coupled with deformation potential theory. The effects of mechanical biaxial strain on the electronic properties, effective mass, and carrier mobility of monolayer MoS<sub>2</sub> were also investigated. It is demonstrated that the electronic properties, such as band structure and density of state, of monolayer MoS<sub>2</sub> are very sensitive to biaxial strain, leading to a direct–indirect transition in semiconductor monolayer MoS<sub>2</sub>. Moreover, we found that the carrier mobility and effective mass can be enhanced significantly by biaxial strain and by lowering temperature. The electron mobility increases over 12 times with a biaxial strain of 10%, while the carrier mobility gradually decreases with increasing temperature. These results are very useful for the future nanotechnology, and they make monolayer MoS<sub>2</sub> a promising candidate for application in nanoelectronic and optoelectronic devices.

**Key words:** MoS<sub>2</sub> monolayer, band gap, strain engineering, mobility, DFT calculations

## INTRODUCTION

Two-dimensional (2D) materials, especially graphene,<sup>1,2</sup> have attracted great interest for applications in nanoelectronic and optoelectronic devices owing to their unique properties.<sup>3</sup> However, graphene is a semimetal with zero band gap,<sup>4</sup> which limits its applications in graphene-based electronic devices, such as field effect transistors (FETs). Recently, molybdenum disulfide (MoS<sub>2</sub>) has been

recognized as a promising material for applications in nanoelectromechanical devices due to its extraordinary mechanical, electronic and transport properties.<sup>5–9</sup> MoS<sub>2</sub> monolayer can be fabricated by various experimental methods, such as chemical vapor deposition<sup>10,11</sup> or a microexfoliation technique which has been used to produce graphene.<sup>12</sup> In contrast to graphene, which is semimetallic with zero band gap, monolayer MoS<sub>2</sub> is a semiconductor with a natural band gap.<sup>13</sup> Thus, monolayer MoS<sub>2</sub> can be useful for such applications as field effect transistors with excellent current on/off ratios (10<sup>8</sup>)<sup>14</sup> and highly sensitive photodetectors.<sup>15</sup>

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Many theoretical research groups have studied the properties of monolayer MoS<sub>2</sub> using first-principles calculations. They focused on the electronic,<sup>16–18</sup> elastic,<sup>19</sup> and optical properties<sup>20–23</sup> of MoS<sub>2</sub>. The functionalization through adatom,<sup>24,25</sup> molecular adsorption,<sup>26</sup> and vacancy defect creation<sup>27–29</sup> in MoS<sub>2</sub> have been also investigated by different methods. In addition, the effect of strain on electronic states and optical properties of monolayer MoS<sub>2</sub> has been considered both theoretically and experimentally.<sup>30–34</sup> Lloyd and co-workers<sup>33</sup> experimentally studied the effect of ultra-large biaxial strain on the band gap of monolayer MoS<sub>2</sub>. The effect of local strain on the band structure of multilayer 2D transition-metal di-chalcogenide (TMD) materials has been investigated both theoretically and experimentally by Dhakal's group.<sup>34</sup> The stability and electronic and magnetic properties of MoS<sub>2</sub> nanoribbons have also been investigated.<sup>35</sup> Recently, we systematically investigated the electronics of monolayer MoS<sub>2</sub> using density functional theory (DFT) calculations.<sup>36</sup> Effects of the in-plane (*xy* plane) biaxial strain on electronic properties have also been considered.<sup>36</sup> In the present work, we estimate the fluctuation of the carrier effective mass in 2D monolayer MoS<sub>2</sub> under small strain. The role of strain in the change of the electronic and transport properties of monolayer MoS<sub>2</sub> is also investigated. Our results may be useful for applications of monolayer MoS<sub>2</sub> in electronic and optoelectronic devices.

## THEORETICAL MODEL AND METHOD

The *ab initio* calculation was performed with the DFT method using generalized gradient approximation (GGA)<sup>37</sup> for the exchange-correlation energy, which is implemented in the Quantum Espresso package.<sup>38</sup> The GGA with Perdew-Burke-Ernzerhof (PBE) exchange-correlation potential was used with projected augmented wave. The electronic wavefunctions were described by a plane wave basis set with an energy cutoff of 410 eV. The Brillouin zone sampling with the Monkhorst-Pack method of (9 × 9 × 1) Monkhorst-Pack *k*-grid mesh was chosen for the calculations. A vacuum layer of 20 Å in thickness was added on the top of the monolayer MoS<sub>2</sub> to avoid interaction between layers. The structure is fully relaxed with an energy convergence of 10<sup>-6</sup> eV and a force convergence of 0.01 eV/Å.

A scheme of the monolayer MoS<sub>2</sub> with hexagonal symmetry under biaxial strain is shown in Fig. 1. The strained cell is designed by stretching the hexagonal ring in the *xy* plane. The strain engineering is applied in a biaxial expansion along the *xy*-direction. The component of biaxial strain is denoted by  $\epsilon$ . In the present work, a wide range of strain (up to 10%) was employed.

At room temperature, the electron velocity  $v$  was of the magnitude of 10<sup>7</sup> cm/s. The lattice constant of

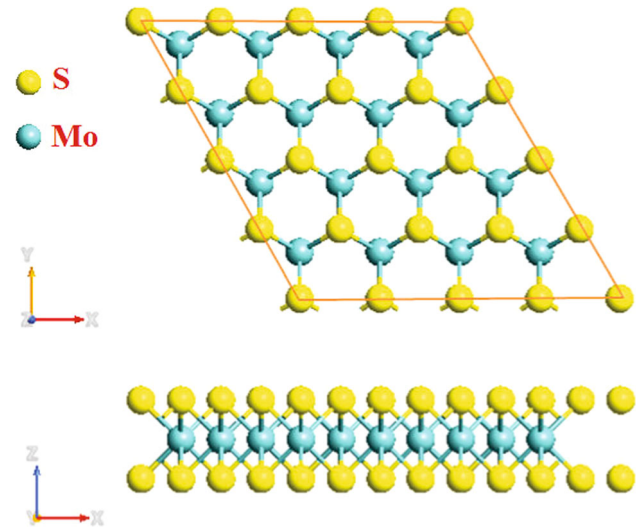


Fig. 1. Top (a) and side (b) views of the relaxed atomic structure of MoS<sub>2</sub> monolayer.

monolayer MoS<sub>2</sub> was much smaller than the wavelength of the electron ( $\lambda \approx 7$  nm). Hence, we believe that the delocalized charge was scattered only by the acoustic phonons and we can use the deformation potential theory proposed by Bardeen and Shockley<sup>39</sup> to describe this scattering process. In the effective mass approximation and electron-acoustic phonon scattering mechanism in a 1D system, the mobility can be defined via the average value of the momentum relaxation time  $\tau$  as follows<sup>40</sup>

$$\mu_{2D} = \frac{e\tau}{m^*} = \frac{2e\hbar^3 C}{3k_B T |m^*|^2 E_1^2}, \quad (1)$$

where  $E_1$  is the deformation potential constant denoting the shift of the valence band maximum for holes and the conduction band minimum for electrons,  $e$  is the electron charge,  $m^* = \hbar^2(\partial^2 E/\partial k^2)^{-1}$  is the effective mass of the charge,  $k_B$  is the Boltzmann constant,  $T = 300$  K is the temperature in the present calculations, and  $C$  is the stretching modulus of the crystal for simulating the lattice distortion activated by strain. The stretching modulus for the 2D system is  $C^{2D} = [\partial^2 E/\partial \delta^2]/S_0$ , where  $E$  is total energy of the system,  $\delta$  is the applied uniaxial strain, and  $S_0$  is the area of the optimized structure. To consider the effect of the temperature on mobility, we calculate the carrier mobility of MoS<sub>2</sub> at several temperatures in the range from 100 K to 400 K.

## RESULTS AND DISCUSSION

We first investigated the electronic properties of the monolayer MoS<sub>2</sub> using DFT calculations. We used the GGA to optimize the geometry of the monolayer MoS<sub>2</sub>. The atomic structure and the model of the applied strain engineering of the



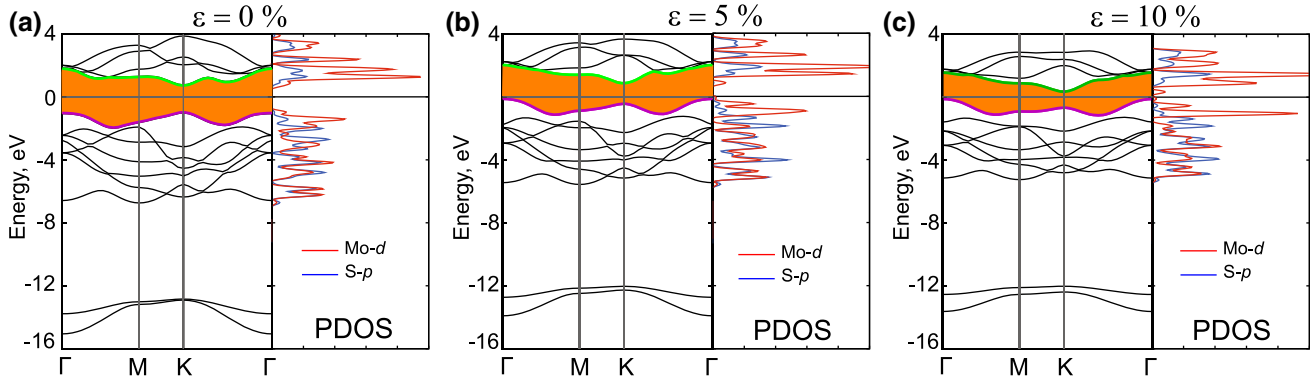


Fig. 2. Band structures and PDOS of monolayer MoS<sub>2</sub> with the applied strains of 0 % (a), 5 % (b) and 10 % (c). The Fermi level is set to 0 eV. In the band structure, the purple and green lines stand for the valence band maximum and the conduction band minimum of MoS<sub>2</sub> monolayer, respectively.

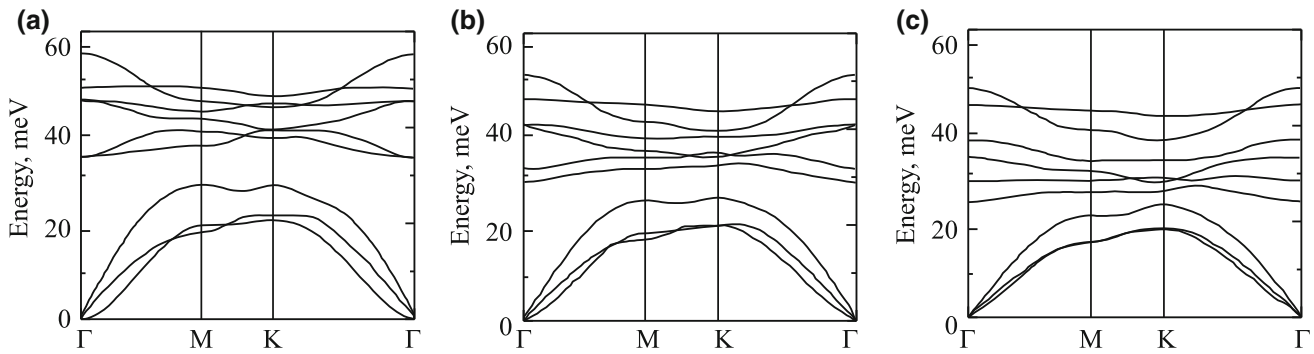


Fig. 3. Phonon dispersion curves of MoS<sub>2</sub> monolayer under biaxial strains of 0 % (a), 5 % (b), and 10 % (c).

monolayer MoS<sub>2</sub> are illustrated in Fig. 1. At the equilibrium state, the lattice constant is equal to 3.18 Å and the bond distance between S and Mo atoms is 2.42 Å. This result is in good agreement with the previous theoretical<sup>41,42</sup> and experimental<sup>43</sup> studies. Based on DFT calculations, we see that, in the equilibrium state, the monolayer MoS<sub>2</sub> is a direct semiconductor with band gap of 1.72 eV. This direct band gap is close to the result of the previous DFT calculations by Matte and co-workers.<sup>44</sup> It is well-known that the traditional DFT method underestimates the band gap of materials, however, this trend is not general and depends on the materials considered.<sup>45,46</sup> The band gap problem can be addressed more accurately by using a GW approximation or hybrid functionals.<sup>27</sup> Hence, we believe that our calculated DFT method is a suitable method for considering the transport properties of monolayer MoS<sub>2</sub>.

In Fig. 2a, we show the electronic energy band structure and partial density of states (PDOS) of Mo-*d* and S-*p* orbitals in monolayer MoS<sub>2</sub> at the equilibrium state. At the equilibrium state, the direct band gap of monolayer MoS<sub>2</sub> is at the K point. The lowest energy of the conduction band and the highest energy of the valence band in monolayer MoS<sub>2</sub> are located at the K point. At equilibrium, the

main contributor to the bottom of the conduction band is the Mo-*d* orbitals, and the contributors to the roof of the valence band are the Mo-*d* and S-*p* orbitals. Mo-*d* and S-*p* orbitals are hybridized with each other at the top of the valence band. This character indicates that the Mo-S bond is strong. However, the mirror symmetrical bonding configuration in the trilayer S-Mo-S system results in a weak  $\pi$  bond-like interaction. This weak interaction is very sensitive to strain, leading to a change of band structure in the presence of strain, as shown in Fig. 2b and c.

Our calculations demonstrate that biaxial strain along the *xy*-direction has a significant effect on the band gap and PDOS of monolayer MoS<sub>2</sub> (see Fig. 2). The electronic properties of MoS<sub>2</sub> are particularly sensitive to the mechanical strain. Under biaxial strain, monolayer MoS<sub>2</sub> becomes an indirect gap semiconductor. The lowest energy of the conduction band is still located at the K point, while the highest energy of the valence band is now at the  $\Gamma$  point in the reciprocal lattice space. We can also easily see that a direct-indirect gap transition can be found when biaxial strain is applied, as shown in Fig. 2. A shift of energy levels leads to a change in the nature of the energy band gap of the monolayer MoS<sub>2</sub> from direct to indirect, even in the case of biaxial strain of

**Table I. Deformation potential constant  $E_1$  (eV), stretching modulus  $C^{2D}$  (N/m), effective mass  $m^*$  ( $m_0$ ), relaxation time  $\tau$  (fs), and mobility  $\mu$  (cm<sup>2</sup>/Vs) of carriers in monolayer MoS<sub>2</sub>**

	$E_1$	$C^{2D}$	$m^*$	$\tau$	$\mu$
Electron	11.02	138.2	0.454	20.05	77.30
Hole	5.05	138.2	0.626	69.25	193.60

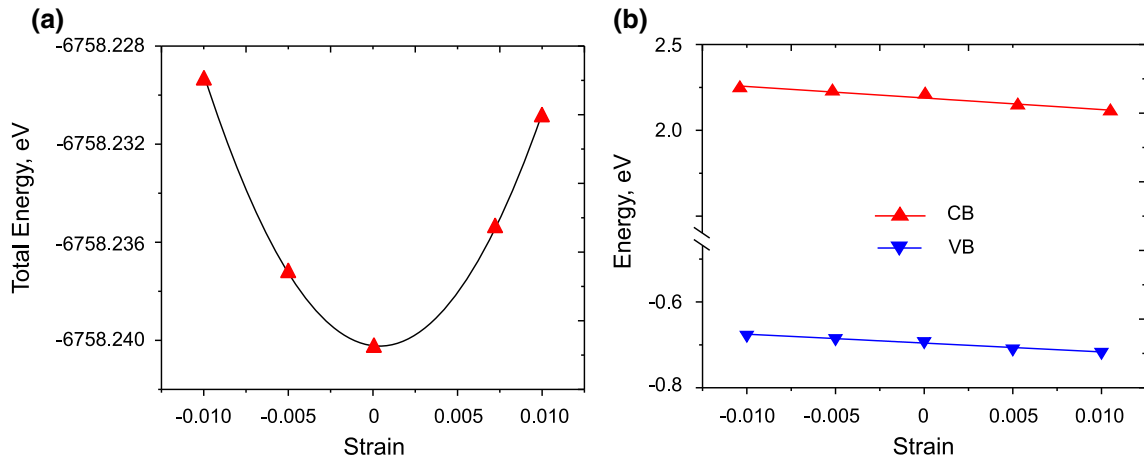
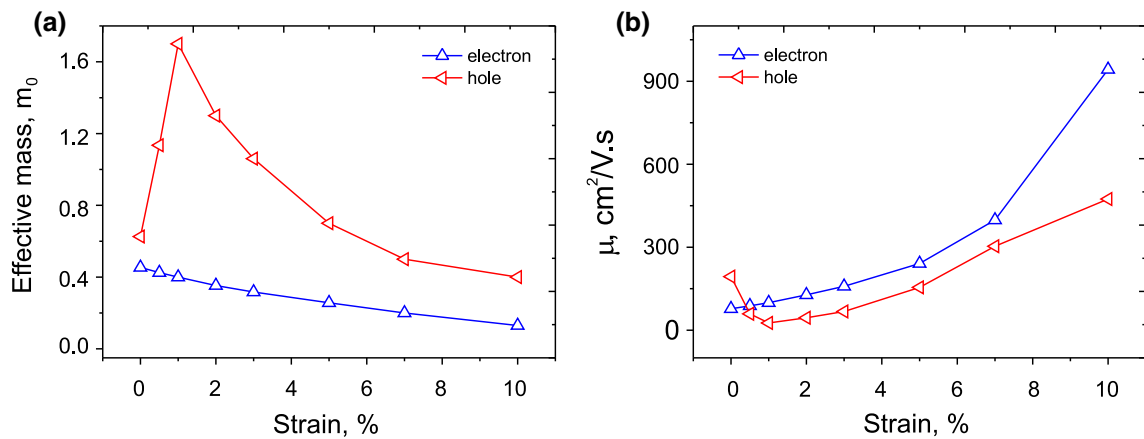
Fig. 4. Dependence of total energy (a) and shifts of the conduction band (CB) and the valence band (VB) (b) of MoS<sub>2</sub> under biaxial strain.

Fig. 5. The carrier effective mass (a) and the carrier mobility (b) as function of biaxial strain.

less than 1%. This means that, in the presence of biaxial strain, the monolayer MoS<sub>2</sub> is an indirect semiconductor. The band gap of monolayer MoS<sub>2</sub> decreases from 1.72 eV to 0.46 eV when the applied strain increases from 0% to 10%. Our calculations also show that with the increasing strain, the valence band maximum is upshifted and the conduction band minimum downshifted, resulting in a decrease of the band gap as shown in Fig. 2.

To consider the structural stability of MoS<sub>2</sub> monolayer under biaxial strain, we also calculate the phonon dispersion curves of monolayer MoS<sub>2</sub> at the equilibrium state (unstrained) and under

biaxial strain, as shown in Fig. 3. The phonon dispersion curves of monolayer MoS<sub>2</sub> without strain count nine phonon modes, as shown in Fig. 3a, which is in complete agreement with the previous results.<sup>47</sup> Under biaxial strain, we can see that the phonon dispersion curves of monolayer MoS<sub>2</sub> are gradually downshifted, resulting in a decrease of the gap between the acoustic and optical branches. As shown in Fig. 3c, we can see that the structure of monolayer MoS<sub>2</sub> is still stable under biaxial strain of 10%.

Next, via the effective mass approximation and electron–acoustic phonon scattering mechanism, we

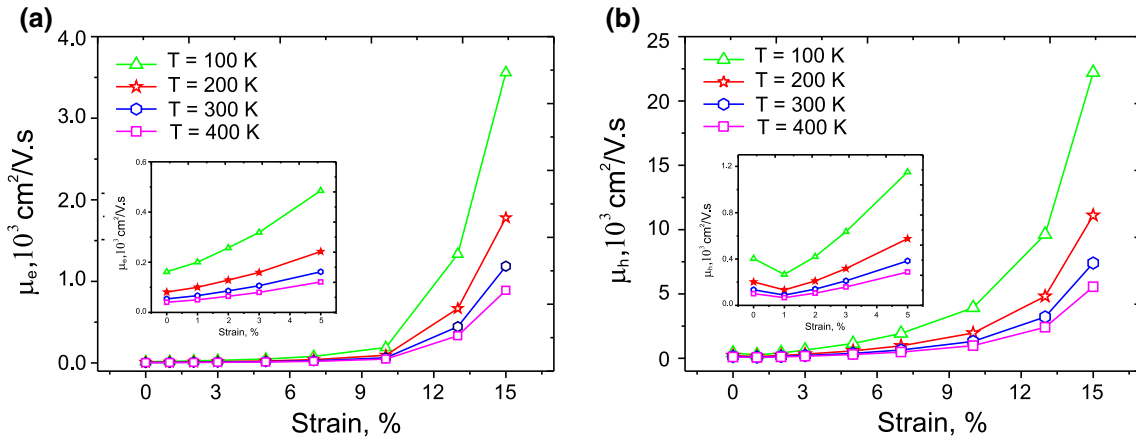


Fig. 6. Dependence of the electron (a) and hole (b) mobility at different temperatures on strain. The insets are the zoom in the strain range from 0% to 5%.

investigate the transport properties of monolayer MoS<sub>2</sub> with and without mechanical strain. To calculate the carrier mobility, we first calculate the effective mass  $m^*$ , the stretching modulus  $C^{2D}$ , and the deformation potential constant  $E_1$ . In Table I, we show these parameters at the equilibrium state of monolayer MoS<sub>2</sub>. Figure 4a shows the dependence of the total energy on the small strain applied along the  $x$  direction. The stretching modulus  $C^{2D}$  is obtained by fitting the energy-strain curves. Figure 4b shows the shift of the band edges as a function of strain along the  $x$  direction. As shown in Table I, the stretching modulus of monolayer MoS<sub>2</sub> at the equilibrium state is 138.2 N/m. These data are in excellent agreement with the previous theoretical calculations by Y. Cai and co-workers.<sup>48</sup> Based on the band structure, we can fit two curves for the top of the valence band and the bottom of the conduction band at the Fermi energy level, whence we get the effective masses  $m_e$  and  $m_h$  for electron and hole, respectively. Our calculations show that, at equilibrium, the effective masses for electron  $m_e$  and hole  $m_h$  are  $0.454m_0$  and  $0.626m_0$ , respectively. These values are in good agreement with previous theoretical studies.<sup>48,49</sup>

The change of the effective mass under strain of monolayer MoS<sub>2</sub> is illustrated in Fig. 5a. The effective mass of monolayer MoS<sub>2</sub> can be controlled by applying biaxial strain. As shown in Fig. 5a, the electron carrier effective mass depends linearly on the biaxial strain. The effective mass of the electron decreases when the biaxial strain increases. The effective mass of the electron drops from  $0.454m_0$  to  $0.257m_0$ , and to  $0.13m_0$  by applying biaxial strains of 0% (unstrained state), 5% and 10%, respectively. Meanwhile, the effective mass of holes experiences a fluctuation as the strain increases. The fluctuation is caused by the valence band maximum (VBM) jumping from the  $K$  point to the  $\Gamma$  point during the

strain induced deformation of the band structure or direct-to-indirect band gap at a strain of 1%.

The effective mass of holes is  $0.626m_0$  at the equilibrium state but abruptly jumps to  $1.721m_0$  with an applied strain of 1%, and then strongly decreases when the applied strain  $\varepsilon > 1\%$ . When the strain further increases, the effective mass of holes begins decreasing to  $0.4m_0$  at a strain of 10%. Besides, the effective mass of holes is slightly larger than that of electrons in all cases of biaxial strain.

We next investigate the electron and hole mobilities of monolayer MoS<sub>2</sub> under strain at a room temperature of 300 K. At this temperature, the hole and electron mobilities are respectively  $193.60 \text{ cm}^2/\text{V}\cdot\text{s}$  and  $77.30 \text{ cm}^2/\text{V}\cdot\text{s}$ . These values are in good agreement with previous theoretical studies.<sup>48</sup> The dependence of the mobility on strain is illustrated in Fig. 5b. We found that the electron mobility monotonically increases with increasing strain, whereas the hole mobility reaches a minimum at a biaxial strain of 1%, then also increases with increasing strain. The electron mobility increases from  $77.30 \text{ cm}^2/\text{V}\cdot\text{s}$  to  $241.21 \text{ cm}^2/\text{V}\cdot\text{s}$  by three times and to  $942.73 \text{ cm}^2/\text{V}\cdot\text{s}$  by 12 times, when strain increases from 0% to 5% and 10%, respectively. The hole mobility exhibits a large reduction from  $193.60 \text{ cm}^2/\text{V}\cdot\text{s}$  to  $26.25 \text{ cm}^2/\text{V}\cdot\text{s}$  when the strain increases from 0% to 1%. This reduction is caused by the direct-to-indirect band gap transition with the valence band shifting from the  $K$  point to the  $\Gamma$  point at the strain of 1%. When the strain further increases, the hole mobility begins to increase and reaches  $474.17 \text{ cm}^2/\text{V}\cdot\text{s}$  when increasing strain to 10%. Figure 5b also shows that the hole mobility is slightly larger than the electron mobility in the unstrained state, but becomes smaller with biaxial strain.

Additionally, the carrier mobilities of electrons and holes of monolayer MoS<sub>2</sub> at various temperatures (100 K, 200 K, 300 K, and 400 K) are also considered. Figure 6a and b illustrate the temper-

ature dependent carrier mobilities under strain. The electron mobility of monolayer MoS<sub>2</sub> under a strain of 10% increases from 707 cm<sup>2</sup>/Vs at  $T = 400$  K to 2800 cm<sup>2</sup>/Vs at  $T = 100$  K, whereas, at the equilibrium state, the hole mobility decreases from 580.80 cm<sup>2</sup>/Vs to 145.20 cm<sup>2</sup>/Vs when the temperature increases from 100 K to 400 K. Our study indicates that the carrier mobility is inversely proportional to the temperature. As mentioned above, the relaxation time for acoustic phonon scattering is independent of the carrier energy, and they depend on the temperature. Thus, according to Eq. 1, it indicates that the mobility acquires a  $\mu \sim T^{-1}$  dependence characteristic for 2D systems and layered materials dominated by acoustic phonon scattering. Our study also shows a very interesting observation with detailed information on the effects of strain on the carrier effective mass and mobility in monolayer MoS<sub>2</sub>, which is very helpful for the future of MoS<sub>2</sub> for applications in nanoscale electronics and photonics devices.

## CONCLUSION

In summary, by using density functional theory, we investigated the effects of biaxial strain on the electronic properties, effective masses and carrier mobilities of 2D monolayer MoS<sub>2</sub>. It was demonstrated that the electronic and transport properties of monolayer MoS<sub>2</sub> are very sensitive to biaxial strain. The results showed that the band gap of monolayer MoS<sub>2</sub> is reduced monotonically when increasing biaxial strain. Furthermore, we found the direct-to-indirect band gap transition in monolayer MoS<sub>2</sub> by applying biaxial strain of  $E_b \geq 1\%$ . At the unstrained state the effective masses and carrier mobility for electron (hole) of monolayer MoS<sub>2</sub> are  $0.454m_0$  ( $0.626m_0$ ) and  $77.30$  cm<sup>2</sup>/Vs ( $193.60$  cm<sup>2</sup>/Vs), respectively. Moreover, we have found that the carrier mobility can be enhanced significantly by biaxial strain and by lowering temperature. These results supply a fascinating observation with detailed information on the effect of biaxial strain on carrier effective mass and mobility in monolayer MoS<sub>2</sub>, which is very helpful for future applications of monolayer MoS<sub>2</sub> in nanoelectronic and optoelectronic devices.

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## CONFLICT OF INTEREST

The authors declare that they have no conflict of interest.

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